



#### **■ INTRODUCTION**

MES Series are constructed with metallized polyester film dielectric, copperply lead and epoxy resin powder coating. They are suitable for blocking, coupling, decoupling, filtering, bypass timing circuit and ideal for use in telecommunication equipment, data processing, equipment, industrial instruments, automatic control systems, and other general electronic equipment.

#### **■ FEATURES**

- High moisture resistance
- Good solderability
- Non-inductive construction
- Self-healing property
- Miniature size
- Standard 5mm lead spacing
- · Wide rated voltage range
- · Wide rated capacitance range
- · Available for wire automatic insertion range

#### CONSTRUCTION

Dielectric: Metallized Polyester Film

· Winding: Non-inductive type

 Lead Wire: Tinned Wire (Cu wire) or Tinned Copper Clad Wire. Lead Free Solder

• Inner Coating: epoxy resin

• Outer Coating: Flame retarding epoxy resin (UL-94V-0)

• Conditional Standard Test: Temperature of from 15°C to 35°C. RH45 to 75%.

#### **■ SPECIFICATIONS**

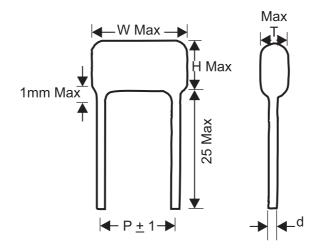
Item	Performance
Operating Temp. Range	-40°C ~ 125°C (VR Derates 1.25% per °C over 105°C)
Capacitance Range	0.001μF ~ 1.2 μF
Capacitance Tolerance	± 5%(J), 10%(K), +20%(M)
Rated Voltage VR 85°C	50/63Vdc, 100Vdc, 250Vdc, 400Vdc, 630Vdc
Dissipation Factor	1.0%(0.01)max @ 1Khz, 25°C
Insulation Resistance	$V_R \le 100 V_{DC} \ge 15000 MΩ$ (C ≤ 0.33 μF) ≥ 5000 MΩ x μF (C > 0.33 μF) $V_R \le 100 V_{DC} \ge 30000 MΩ$ (C ≤ 0.33 μF) ≥ 10000 MΩ x μF (C > 0.33 μF)

#### **■ PERFORMANCE**

Item	Metalized Polyester
Capacitance Drift	Cycled through the operating temperature range 2%.
Humidity Test	Will withstand the test of R.H. 95% at 40°C for 1000hrs. $C \le 5\%$ DF < 1.2% IR > 10000M $\Omega$
Load Test	Will withstand a testing voltage at 140% of W.V. for 1000hrs at 85°C. C≤5% DF < 1.2% IR > 5000MΩ
Lead Pull Test	Will withstand a pull of 1.5Kg applied axialy for 10 seconds.
Lead Bend Test	Will sustain two cycles without breaking when attaching a load of 0.5Kg to the end of the lead and then rotating the capacitor 90° from the direction of lead egress. Then 180 in opposite direction, then back to the starting point.
Solderability	Immersed in molten solder ( $230 \pm 0.5$ sec.) after testing, the wound lead and gap in the wound lead will be covered and filled by solder. Will be difficult to unwind by finger.
Dielectric Strength	Shall withstand 200% or 160% of rated voltage at 25°C for 1 minute with current limiting resistance of 1 $\Omega$ / $V$ .





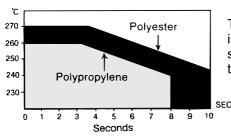


#### ■ MAXIMUM DIMENSIONS (mm)

	W. V.	5	50 / 63VDC (1H/1J)				100	0VD	C (2	(A)			250VDC (2E) 400V			400VDC (2G)				630VDC (2J)											
( μF) T	code	W	Н	Т	Р	d	V/µs	W	Н	Т	Р	d	V/µs	W	Н	Т	Р	d	V/µs	W	Н	Т	Р	d	V/µs	W	Н	Т	Р	d	V/µs
0.001	102	6.5	6.5	3.5	_	0.5	10	6.5	6.5	3.5	5	0.5	15	6.5	6.5	3.5	5		50	6.5	6.5	3.5	5	0.5	50	6.5	6.5	3.5	_	0.5	50
0.002	122	6.5	6.5	3.5		0.5	10	6.5	6.5	3.5	5	0.5	15	6.5	6.5	3.5			50	6.5	6.5	3.5	5	0.5	50	6.5	6.5	3.5		0.5	50
0.003	332	6.5	6.5	3.5	-	0.5	10	6.5	6.5		5	0.5	15	6.5	6.5	3.5	5	0.5	50	6.5	6.5	3.5	5	0.5	50	6.5	6.5	3.5	_	0.5	50
0.005	472	6.5	6.5	3.5	-	0.5	10	6.5	6.5	3.5	5	0.5	15	6.5	6.5	3.5	5	0.5	50	6.5	6.5	3.5	5	0.5	50	6.5	6.5	3.5	5	0.5	50
0.006	562	6.5	6.5	3.5	_	0.5	10	6.5	6.5	3.5	5	0.5	15	6.5	6.5	3.5	_	0.5	50	6.5	6.5	3.5	5	0.5	50				_		
0.007	682	6.5	6.5	3.5	_	0.5	10	6.5	6.5	3.5	_	0.5	15	6.5	6.5	3.5	_		50	6.5	6.5	3.5	5	0.5	50						
0.008	822	6.5	6.5	3.5	-	0.5	10	6.5	6.5	3.5	5	0.5	15	6.5	6.5	3.5	-		50	6.5	6.5	3.5	5	0.5	50						
0.010	103	6.5	6.5	4.0	-	0.5	25	6.5	6.5	4.0	5	0.5	25	6.5	6.5	3.5			50	6.5	6.5	3.5	5	0.5	50						
0.012	123	6.5	6.5	4.0	_	0.5	25	6.5	6.5	4.0	_	0.5	25	6.5	6.5	3.5	-		50												
0.015	153	6.5	6.5	4.0	_	0.5	25	6.5	6.5	4.0	5	0.5	25	6.5	6.5	3.5	5	0.5	50												
0.018	183	6.5	6.5	4.0	5	0.5	25	6.5	6.5	4.0	5	0.5	25	6.5	6.5	3.5	5	0.5	50												
0.022	223	6.5	6.5	4.0	5	0.5	25	6.5	6.5	4.0	5	0.5	25	6.5	6.5	3.5	5	0.5	50												
0.027	273	6.5	6.5	4.0	5	0.5	25	6.5	6.5	4.0	5	0.5	25	7.5	9.5	3.5	5	0.5	30												
0.033	333	6.5	6.5	4.0	5	0.5	25	6.5	6.5	4.0	5	0.5	25	7.5	9.5	4.5	5	0.5	30												
0.039	393	6.5	6.5	4.0	5	0.5	25	6.5	6.5	4.0	5	0.5	25	7.5	9.5	4.5	5	0.5	30												
0.047	473	6.5	6.5	4.0	5	0.5	25	6.5	6.5	4.0	5	0.5	25	7.5	9.5	4.5	5	0.5	30	7.5	10	6	5	0.6	30						
0.056	563	6.5	6.5	4.0	5	0.5	25	6.5	6.5	4.0	5	0.5	25	7.5	9.5	4.5	5	0.5	30												
0.068	683	6.5	6.5	4.0	5	0.5	25	6.5	6.5	4.0	5	0.5	25	7.5	9.5	4.5	5	0.5	30												
0.082	823	6.5	6.5	4.0	5	0.5	25	6.5	6.5	4.0	5	0.5	25	7.5	9.5	4.5	5	0.5	30												
0.1	104	6.5	6.5	4.5	5	0.5	25	6.5	6.5	4.5	5	0.5	25	7.5	9.5	4.5	5	0.5	30												
0.12	124	6.5	6.5	4.5	5	0.5	25	6.5	6.5	4.5	5	0.5	25	7.5	10	5.0	5	0.5	30												
0.15	154	6.5	6.5	4.5	5	0.5	25	6.5	6.5	4.5	5	0.5	25	7.5	10	5.0	5	0.5	30												
0.18	184	6.5	6.5	4.5	5	0.5	25	6.5	6.5	4.5	5	0.5	25	7.5	10	6.0	5	0.5	50												
0.22	224	6.5	6.5	4.5	-	0.5	25	6.5	6.5	4.5	5	0.5	25	7.5	10	6.0	5	0.5	50												
0.27	274	6.5	6.5	4.5	5	0.5	25	6.5	6.5	4.5	5	0.5	25	7.5	11	7.0	5	0.5	50												
0.33	334	6.5	6.5	4.5	_	0.5	25	6.5	6.5	4.5	5	0.5	25	7.5	11	7.0	5	0.5	50												
0.39	394	6.5	6.5	4.5	5	0.5	25	7.5	6.5	4.5	5	0.5	25	7.5	12	8.0	5	0.5	50												
0.47	474	7.0	7.5	4.5	-	0.6	25	7.5	7.5	4.5	-	0.6	25	7.5	12	8.5	5	0.5	50										$\neg$		$\Box$
0.56	564	7.0	8.5	5.0	5	0.6	25	7.5	8.5	5.0	5	0.6	25																T		$\Box$
0.68	684	7.0		5.0	_	0.6	25	7.5	8.5	5.0	-	0.6	25																		一
0.82	824	7.0	8.5	5.0	-	0.6	25	7.5	10	6.0	-	0.6	25				$\exists$												7		-
1.0	105	7.0	10	6.5	-	0.5	25	7.5	10	6.0	-	0.6	25				$\Box$												$\dashv$	$\neg$	
1.2	125	7.0	10	6.5	-	0.6	20	7.5	11	7.0	5	0.6	20										1						7		$\dashv$

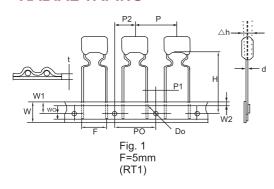


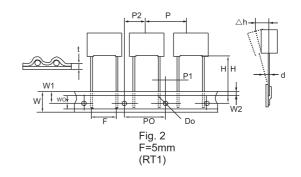
#### **■ SOLDERING**



The area under the curve is the recommended soldering time & temp. for the materials shown.

#### **■ RADIAL TAPING**





#### **■ TAPING SPECIFICATIONS**

Description	Letter	Dimension (mm)
Description	Lotto	RT1
Lead Wire Diameter	d	0.5 / 0.6
Tapping Pitch	Р	12.7
Feed Hole Pitch	РО	12.7
Centering of the Lead Wire	P1	3.85
Centering of the Body	P2	6.35
Lead Spacing (Pitch)	F	5
Component Alignment	Δh	0
Height of Componenet from Tape Center	Н	18.5
Carrier Tape Width	W	18
Hold Down Tape Width	WO	6
Hole Position	W1	9
Hold Down Tape Position	W2	3
Feed Hole Diameter	Do	4
Tape Thickness	t	0.7
Figure	fig	1 or 2

#### PACKAGING

Method	Bulk	Ammo	Reel
Code	В	Α	R

#### ■ TAPE CODE (Lead spacing of tape)

Spacing	5mm
Packing	A or R
Code	RT1 (See Diagram)

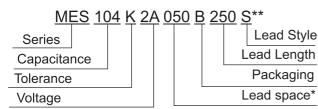
Remark: \*Allowance of accumulated pitch less than 1mm at the sum of 20 pitches.

\*Continuous empty component less than 3 consecutive pieces.

\*Total empty on one reel less than 1%.



#### ■ PART NUMBER EXAMPLE



<sup>\*</sup> Leadspace is straight lead non-formed original leadspace.

#### **■ TOLERANCE**

Code	Tolerance
J	± 5%
K	± 10%
М	± 20%

#### ■ LEAD LENGTH FROM SEATING PLANE

mm	5	10	15	20	25	(Bu
Code	050	100	150	200	250	

(Bulk Pack)

#### ■ RADIAL LEAD SPACING

mm	5
Code	050

<sup>\*</sup> Leadspace is straight lead non-formed original leadspace.

#### ■ LEAD STYLE

Code	Style
S	Straight
K	Kink-In (Stand Off)
F	Form Out

<sup>\*\*</sup> For Bulk packaging with formed leads, add an additional 3 digit lead spacing code at end of part number.

#### **■ CAPACITANCE CODE**

μF	0.01	0.047	0.1	0.47	1.0
pF	10000	47000	100000	470000	-
Code	103	473	104	474	105

#### ■ RATED VOLTAGE

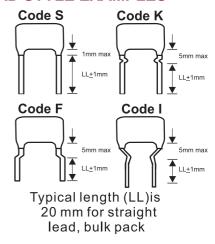
WV	50	63	100	250	400	630
Code	1H	1J	2A	2E	2G	2J

#### ■ STRAIGHT LEAD SPACING (P)

mm	10	15	22.5	27.5	37.5
Code	100	150	225	275	375

<sup>\*</sup> Leadspace is straight lead non-formed original leadspace.

#### ■ LEAD STYLE EXAMPLES



Non-inductive construction, wound with metallized polyester film dielectric.

Capacitor Internal Roll, Metallized Polyester Film

Metal Spray Layer

Leads

High Temperature Wax

Flame Retarding Epoxy Resin (UL94V-0)





		TYPE: MES		
		Product Specifications		
1. Scope				
	dielectric fixed capacitor			
2. Product Name	Miniature Metallized Polyester Film Capacitor			
3. Construction (Dimensions and	Dimensions: Refer to Dimensions Drawing			
Materials)  Materials:				
4. Characteristics	1. Element:	Metallized Polyester Film		
	2. Metal Spray:	Special Solder (Lead Free)		
	3. Lead wire:	Tinned wire (Cu wire) or Tinned copper clad steel (CP wire) Lead Free		
	4. Inner coating:	Epoxy Resin		
	5. Outer coating:	Flame retarding epoxy resin (UL-94V-0 Standard		
	Non-inductive construction, wound with metallized polyester film dielectric.			
	Capac	citor Internal Roll, Metallized Polyester Film		
	Metal	Spray Layer		
	Leads			
		emperature Wax		
	Flame	Retarding Epoxy Resin (UL94V-0)		
		CHARACTERISTICS		
	Stan	dard Atmospheric Conditions		
Unless otherwise specified		atmospheric conditions for making measurements and tests is as follows:		
Ambient Temperature:	T			
Relative Humidity:	45 to 85%			
Air Pressure:				
	<u> </u>	ults, measurements shall be made wtihin the following limits:		
Ambient Temperature:	20°C to 5°C	ato, measarements shall be made walling the following limits.		
Relative Humidity:				
Operating Temperature Range				
Rated Temperature Range	atar 5 man 85			
		erature for which the capacitor can be operated continuously at rated voltage.		
Nated Temperature Nange is the		RICAL CHARACTERISTICS		
Rated Voltage (Vg):	50/63 Vdc, 100 Vdc, 2	50 Vdc, 400 Vdc, 630 Vdc		
Category Voltage (Vc):	105°C	Vc = Vg		
For temperatures over 105°C, a d	lecreasing factor of 1.25	5% per degree celcius °C on the nominal voltage Vg has to be applied.		
Rated upper limit temperature:	105°C			
Usable upper limit temperature:				
Capacitance Range:	0.01μF to 10μF			
Capacitance Tolerances:	(Measured at 1KHz, 1V) ±5% ( J ), ±10% ( K ), ±20% ( M ),			
Dissipation Factor: (DF%)  LCR METER: HP -4284A, at 20°C ±5°C  1.0% (max.) at 1 KHz.		A, at 20°C ±5°C		
	1.5% (max.) at 10 KHz	<u>'</u> .		





ELECTRICAL CHARACTERISTICS (continued)					
Took oon dikinga	Insulatio	n resitance between terminals			
Test conditions:	20°C 15°C				
Temperature:	20°C ±5°C				
Voltage charge time:	1 minute				
Voltage charge:	100 Vdc				
Performance:	>0000140	fr., C < 0.22E			
	≥9000MΩ	for C ≤ 0.33 μF			
Tost voltage between terminals.	≥3000MΩ x μF	for C > 0.33 μF			
Test voltage between terminals:	IF°C /out off oursent 10m				
1.6 x Vg applied for 2 sec, at 20°C : Performance:					
	There shall be no dielec	ctric breakdown or other damage.			
Dielectric strength:  Between terminal and enclosure					
		aura far 2 ta F accords			
Apply 200% of rated voltage between Method of the test as described by		sure for 2 to 5 seconds.			
Put the 1mm diameter of small me					
		Ilia halla Distance of the matallic halla and the terminal aball hallout about			
·	•	allic balls. Distance of the metallic balls and the terminals shall be kept about			
9		ted terminals and the metallic balls			
Performance:	There should be no die	lectric breakdown or other damage			
		About 2 mr  Small metallic ball			
Rapid change of temperature. (Te	sting method IEC 68-2-2	1)			
The test capacitor shall be kept in	the testing oven and be	kept at conditions of the following table, and it shall be repeated for 5 cycles e at the ordinary conditions for 2 hours.			
	Step temperature  1 -40±3 2 ordinary 3 110±2 4 ordinary	minute 30± 3 3 or under 30 ± 3 3 or under			
Performance:					
Capacitance change ΔC/C:	≤ ± 10%				
DF change Δtan δ:	≤ 0.5% at 1KHz				
Insulation resistance:	≥ 50% at limit value				
insulation resistance.		NICAL CHARACTERISTICS			
Terminal strength (Testing method	HIFC 68-2-21)				
Tensile: (Test Ual)	A 120 00 2-211				
Tensile. (Test out)	A load of 10N (1.0kg) sh 10 seconds.	nall be gradually applied to the terminal in the axial direction and held thus for			
Bending: (Test Ub)					
	While a load of 500g applied to the lead wire, the body of the capacitor shall bent 90° and returned to the original position. This operation shall be conducted in a few seconds. Then the body shall be bent 90° in the opposite direction and returned to the original position.				
Performance:	T				
	There shall be no such	mechanical damage as terminal damage, etc.			





ENDURANCE CHARACTERISTICS				
Solderability: (Testing method	IEC 68-2-20 Ta)			
	Solder temperature:	245°C ±5°C		
	Immersion time:	2.5 ± 0.5 seconds		
Performance:				
	At least 95% of the circ solder.	cumferential face of lead wire up to immersed lecvel shall be covered with new		
Resistance to soldering heat: (1		) Tb)		
	Solder bath method			
	Solder temperature:	260°C ±5°C		
	Immersion time:	10 ± 1 second		
	Thickness of heat shur			
	(printed wiring board)			
	Performance:	1.011111		
	(Capacitance change			
	$\Delta C/C$	≤ ± 3%		
	DF change Δtan δ:	≤±0.5% at 1 KHz		
Vibratian Draef. /Tasting moth		S = U.3% dt 1 km2		
Vibration Proof: (Testing meth				
	-	The frequency shall be varied form from 10Hz to 55Hz at 1.5mm amplitude and back to 10Hz in		
	· · ·	te intervals. This motion shall be applied for a period of 2 hours in each of 3		
		r directions. During the last 20 min of vibration in each direction, checks shall		
		hort-circuiting and interruption.		
	Performance:	To a sure		
		There shall be no open or short-circuiting and the connections must be		
	Bending strength:	stabilized.		
	Appearance:	There shall be no such mechanical damage as terminal damage, etc.		
Damp heat (steady state): (Tes	ting method IEC 69-2-3 Ca)			
	The capacitor shall be 1000 hours.	stored at a temperature of 40 ±2°C and relative humidity of 90% to 95% for		
		shall be subjected to standard atmospheric conditions for 1 to 2 hours, after		
	which measurement sl	·		
	Performance:	Tan be made.		
	(Capacitance change			
	$\Delta C/C$	≤ ± 5%		
	DF change Δtan δ:	≤ ± 0.5% at 1 KHz		
	Insulation resistance:	≥ 50% of limit value		
Electrical endurance: (Testing r		2 30% Of Illilit value		
Electrical endurance. (Testing I	·			
	hours. And then the capacitor shall be subjected to standard atmospheric conditions for 1 to 2 hours, after which measurement shall be made. The lead resistor in series with the capacitor shall be $20\Omega$ to			
	aπer which measurem 1KΩ.	ent shall be made. The lead resistor in series with the capacitor shall be 2012 to		
	Performance:			
	(Capacitance change			
	ΔC/C)	≤ ± 10%		
	DF change Δtan δ:	≤ ± 0.5% at 1 KHz		
	Insulation resistance:	≥ 50% of limit value		





STORAGE CONDITIONS				
It should be noted that the solderability of the terminals may be deteriorated when stored barely in an atmosphere for long periods.				
It should not be located in particularly high temperature and high humidity, it must submit to the following conditions (Keeping in the				
original package)				
	Temperature:	5°C ~ 35°C		
	Relative Humidity:	≤ 70%		
	Storage Period:	≤ 12 months		
	(following the manufacturing date marked on the label in package bag)			
Capacitors shall avoid the conditions of being wetted by water, oil, salt water and/or poisonous gases.				
If using a capacitor past its storage time, its characteristics should be tested or contact our technical engineer.				